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SAMSUNG MEMORY

Investor Presentation

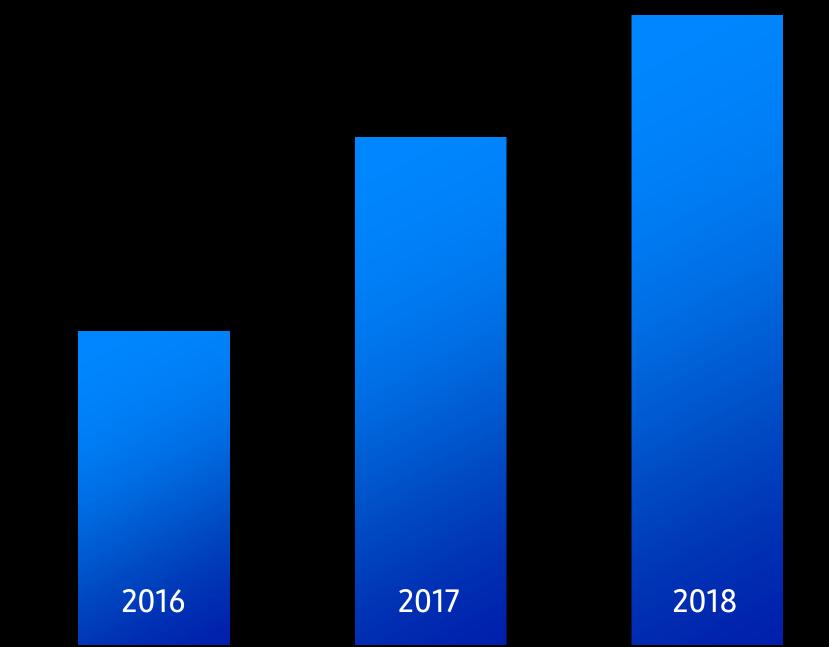
2023

CONTENTS

BUSINESS UPDATE MEMORY MARKET OPPORTUNITIES SAMSUNG STRATEGY

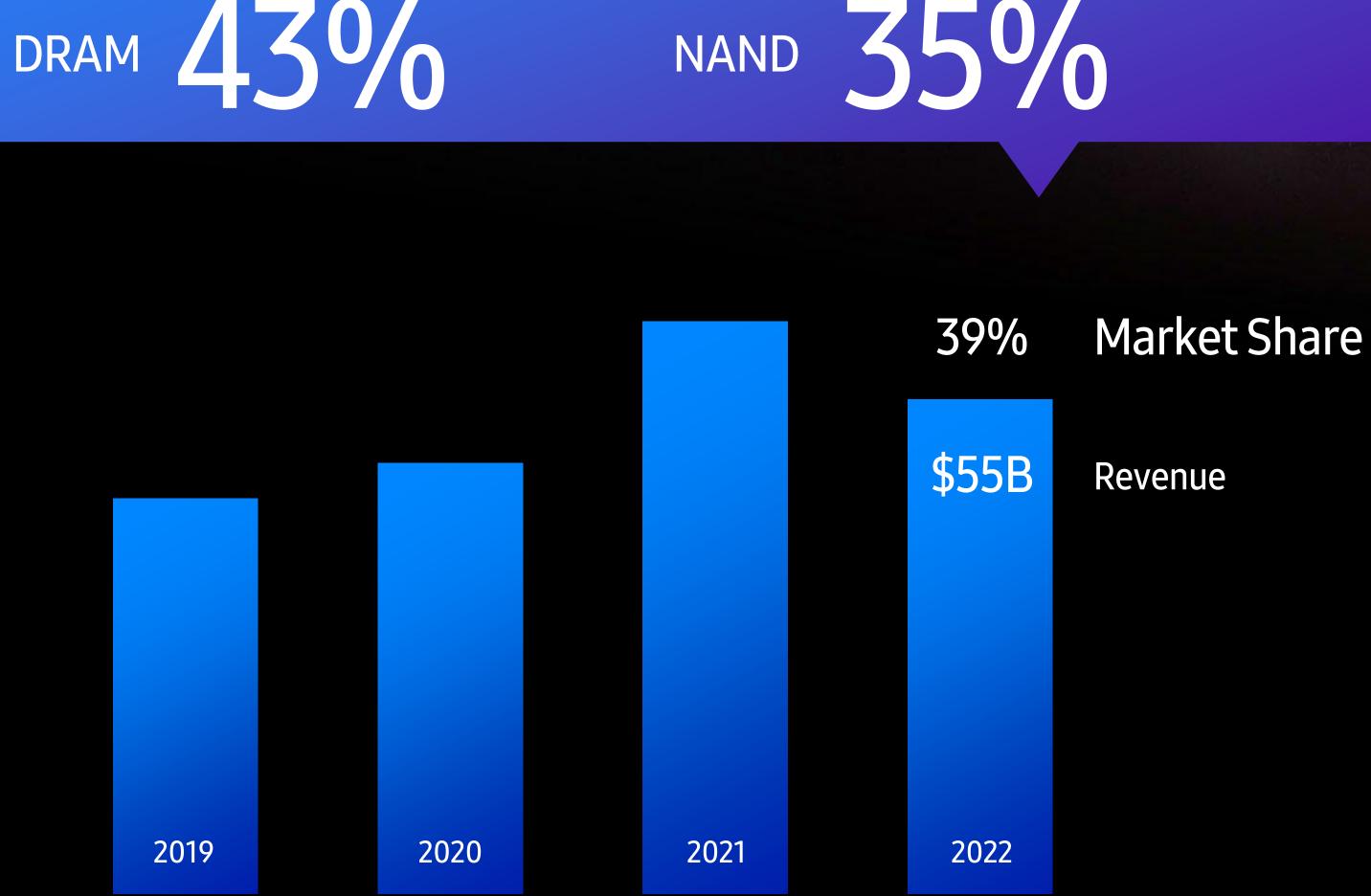
#1 in Memory Worldwide Since 1993, Well Balanced DRAM/NAND Portfolio

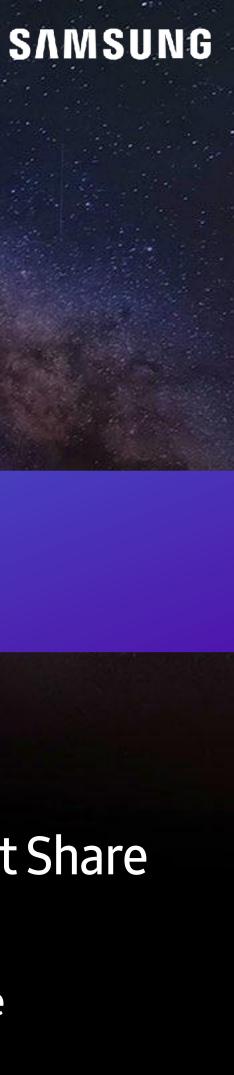
2022 Market Share

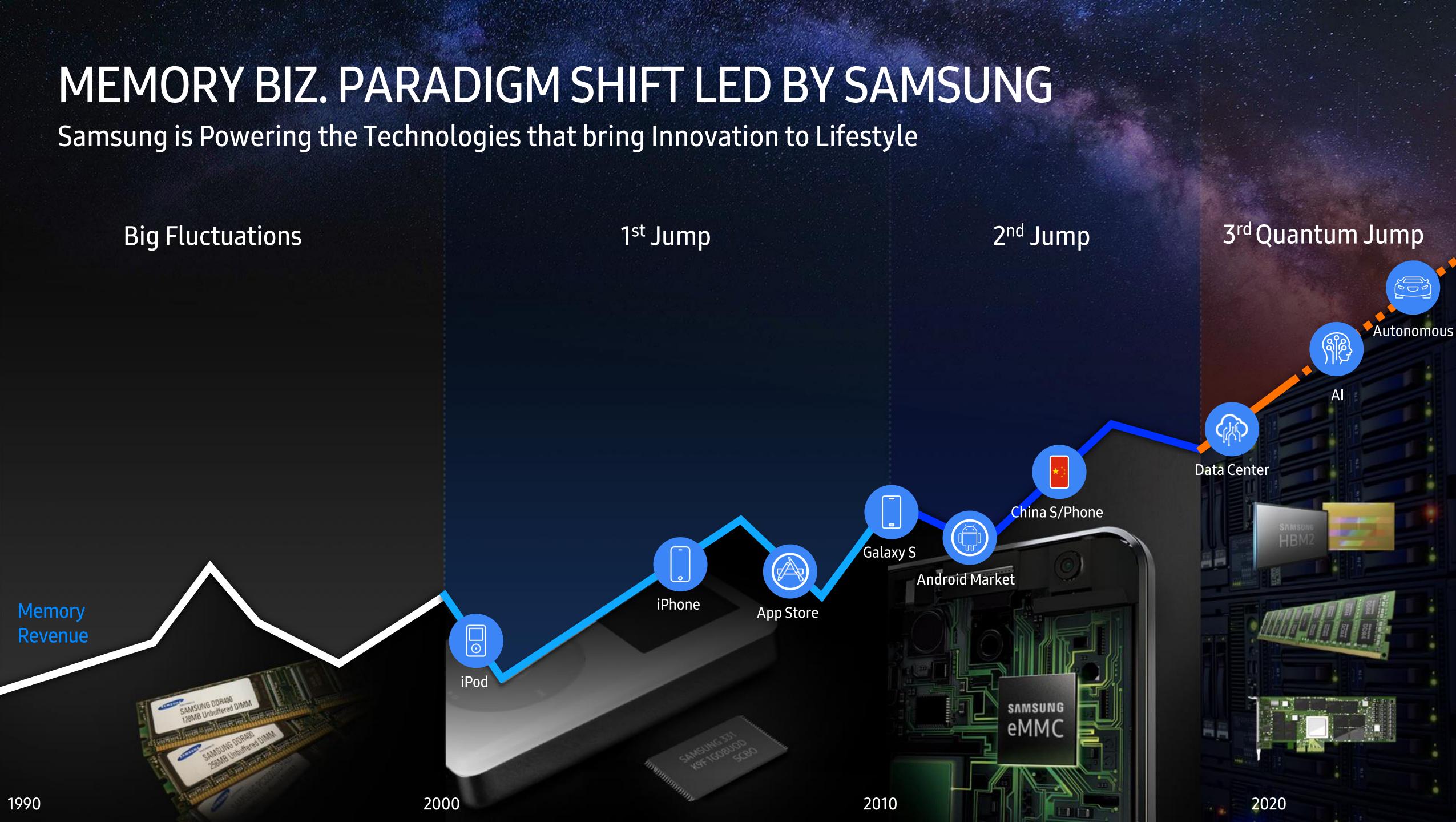


Source: IDC , Mar. '23







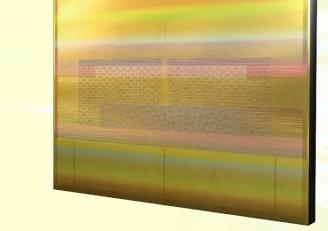


Beyond The Boundary

HUMAN

SAMSUNG HBM3 Icebolt





Samsung Memory



CONTENTS

BUSINESS UPDATE MEMORY MARKET OPPORTUNITIES SAMSUNG STRATEGY

SPREAD-OUT OF PUBLIC CLOUD Explosive Growth of Data



2nd WAVE



Cloud Service Providers



.Com & Forbes Top100



3rd WAVE

THE FLOOD OF DATA 4TH WAVE

Telcos



AI



Automotive

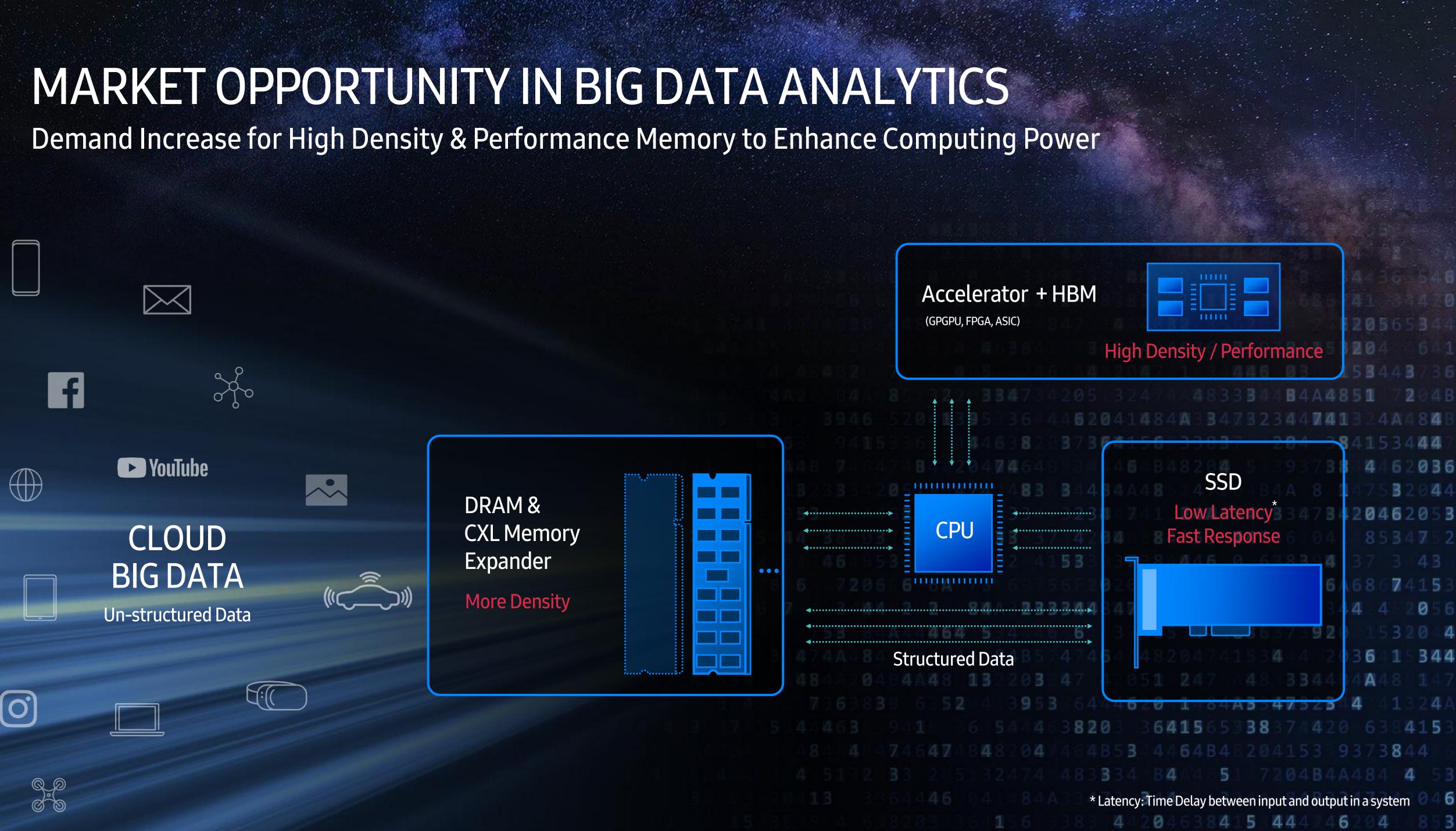


SMART CITY & AUTONOMOUS CAR FUELED BY 5G NETWORK Huge Amounts of Data Generated by Hyper-connected Devices



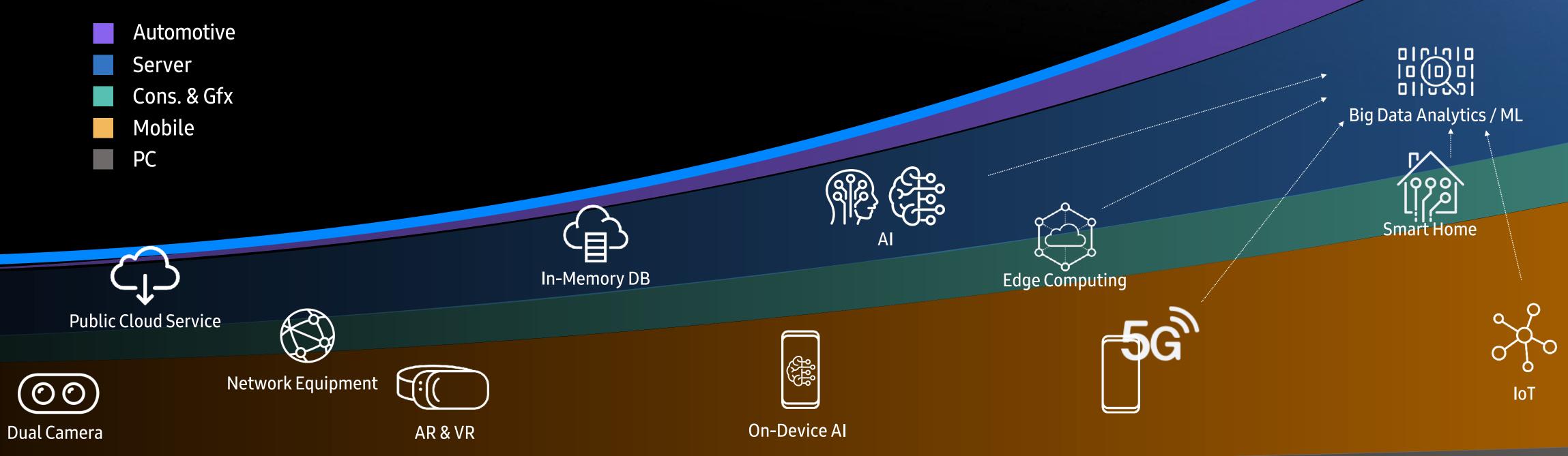


MARKET OPPORTUNITY IN BIG DATA ANALYTICS





CONTINUOUS GROWTH OF MEMORY DEMAND Memory Growth led by Server & Mobile devices based on Big Data Ecosystem







CONTENTS

BUSINESS UPDATE MEMORY MARKET OPPORTUNITIES SAMSUNG STRATEGY

SAMSUNG STRATEGY

Break-through Technology

TECH LEADERSHIP

S/W & CONTROLLERS

Enhanced Solutions

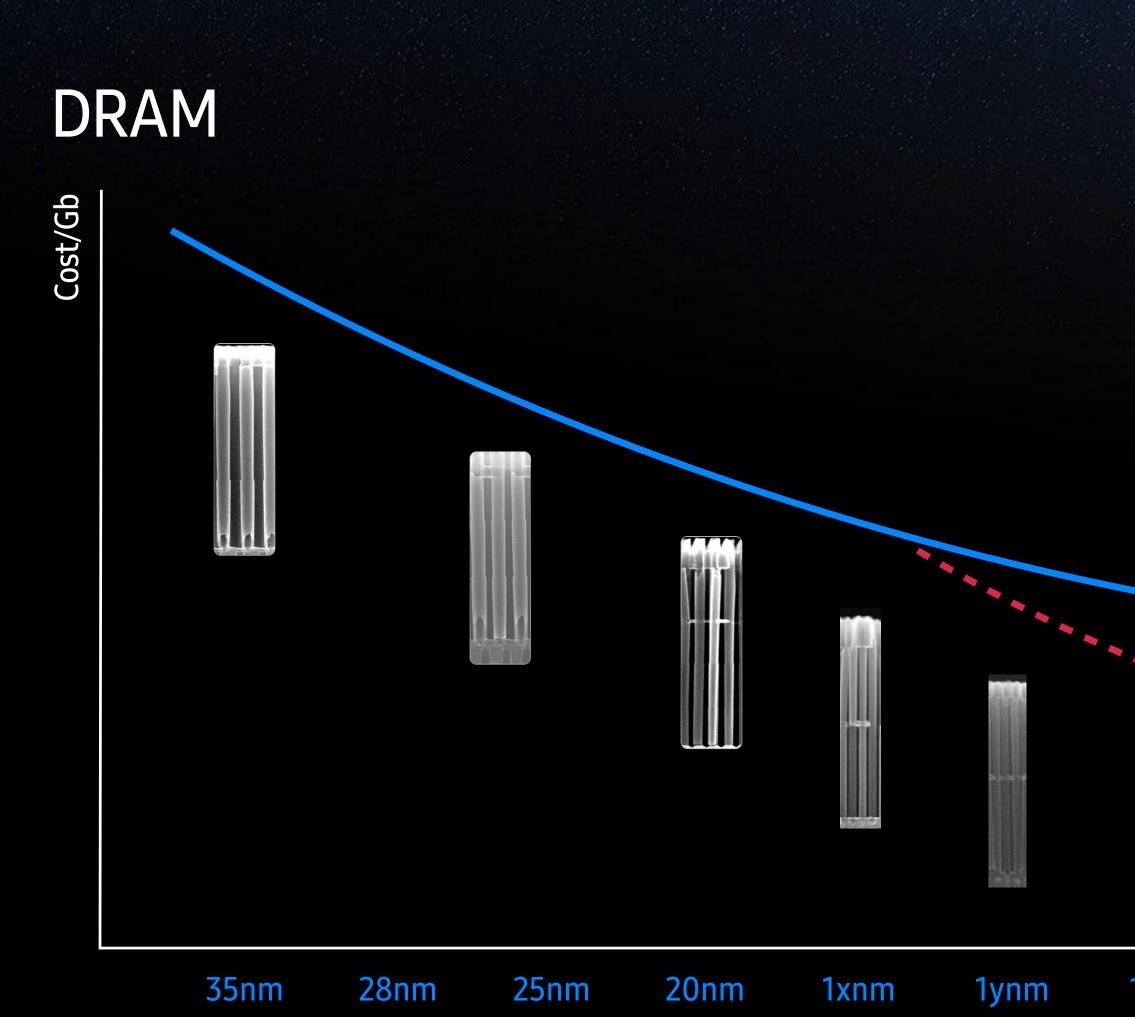
Advanced Manufacturing

EFFICIENCY & FLEXIBILITY



Break-through Technology

CONTINUOUS TECHNOLOGY SCALING Thru Technology Evolution

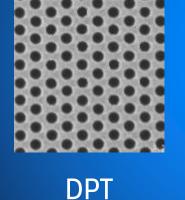


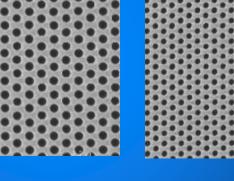
Source: Samsung

BEYOND <10nm

1znm 1anm 1bnm ···

FUTURE DRAM TECHNOLOGY



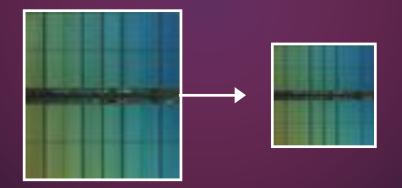


QPT

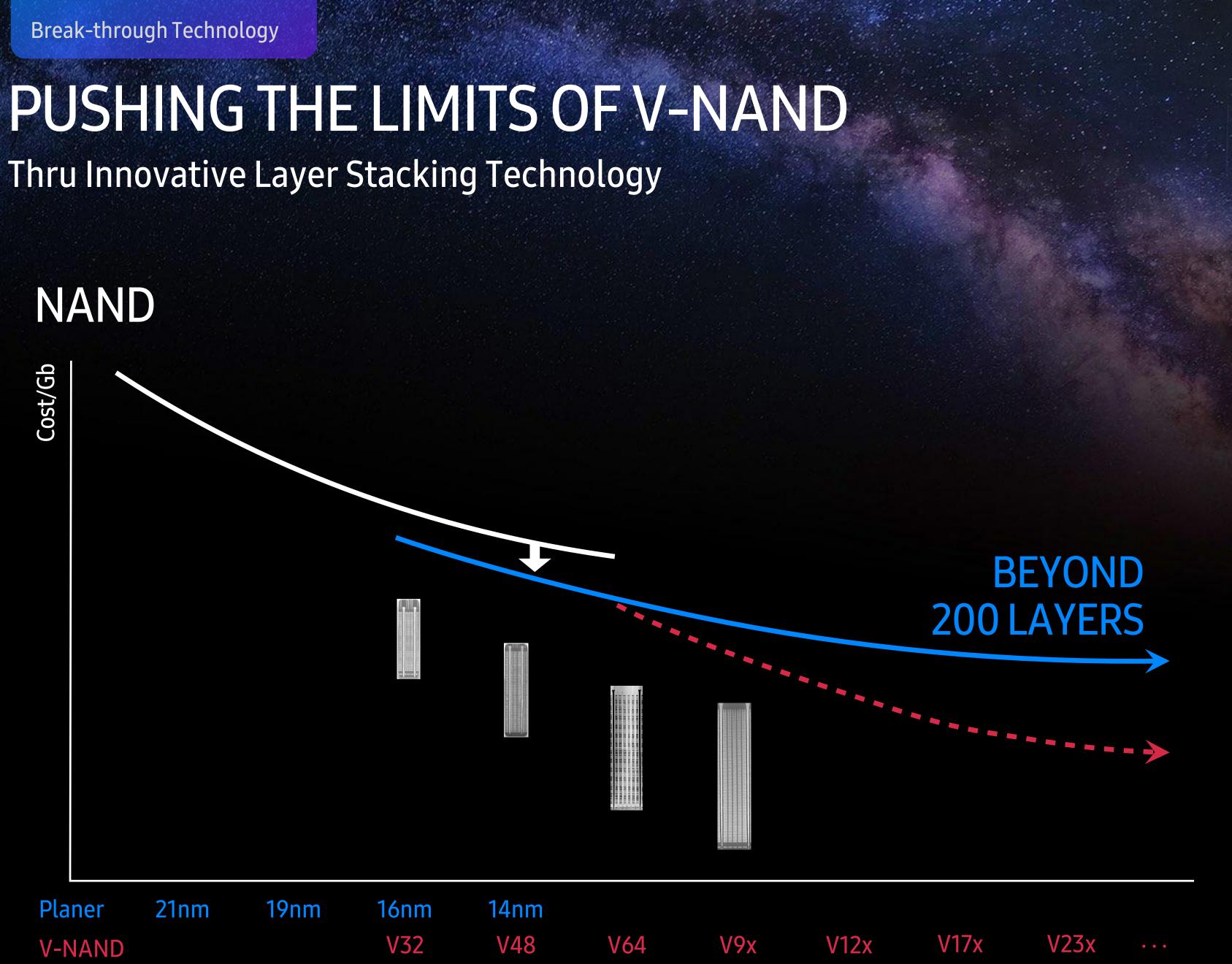
EUV

*DPT : Double Patterning Technology *QPT : Quadruple Patterning Technology *EUV : Extreme Ultra Violet

ADVANDCED DESIGN TECH







FUTURE V-NAND TECHNOLOGY



Vertical Stack-up

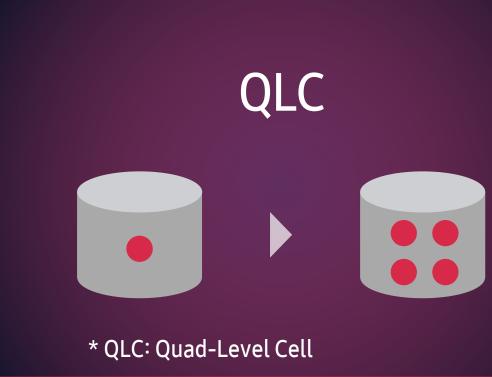
Multi-Stacking



Lateral Shrink



Cell Over Peri





Enhanced Solutions

UNIQUE CAPABILITIES FOR DIFFERENTIATED SOLUTIONS Integrating Key Components to Deliver Value-added Solutions

ADVANCED PROCESS TECHNOLOGY

Wafer / Chip







Higher Density



Less Power Consumption



Faster





ADVANCED PACKAGING TECHNOLOGY

Stacking / TSV

VERTICAL INTEGRATION

Software & Logic (Controller)

Thinner

Smaller

No Performance Loss



SHMSUNG

Customized



Expandable



Smarter



Secure



Enhanced Solutions

SAMSUNG SOLUTIONS FOR THE 5G ERA Enhanced Processing for Massive Data with Lower Latency & Less Power Consumption

FASTER DATA RATES WITH LOW POWER

3DS RDIMM, Z-SSD

Low Latency

High Capacity

Stable QoS

* Latency: Time Delay between input and output in a system



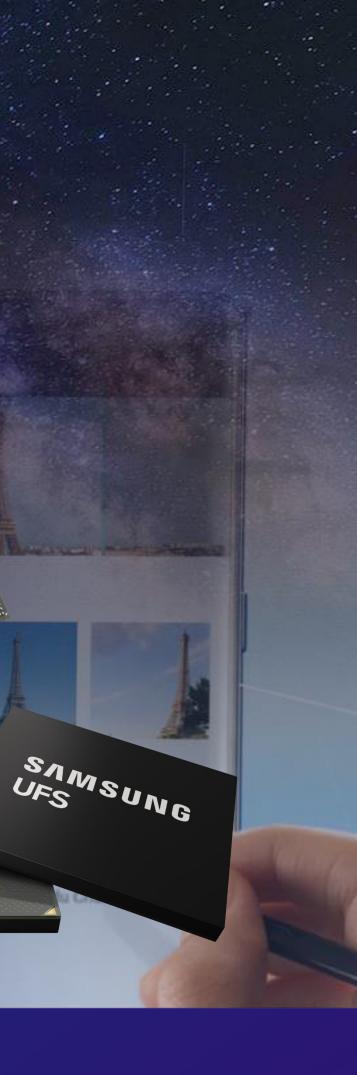
LPDDR5/5X

3-892-70-12-39

Higher Speed

Lower Power Consumption

Smaller Package





24GB HBM3 *

Fastest Performance

Energy Efficiency

* HBM: High Bandwidth Memory

32TB SAS SSD, 16TB NVMe SSD

Largest Density

Higher Reliability

Unparalleled Performance

Enhanced Solutions

SAMSUNG SOLUTIONS FOR AUTOMOTIVE INDUSTRY Advanced Total Memory Solution for Autonomous Driving Technology



Automotive Storage

High Density

High Performance

High Reliability

Dedicated Support for automotive

- Full Memory Line-ups
- Quality & Longevity
- Full In-house Solution

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CONNECTED AUTONOMOUS

SAMSUNG LPDDR4X

Automotive DRAM

SAMSUNG

LPDDR5

High Bandwidth

Lower Power Consumption

Higher Reliability



Advanced Manufacturing

APPLICATION-ORIENTED LINE MANAGEMENT 2-Track Strategy for Efficient Production & Capacity Allocation

HIGH PERFORMANCE COMPUTING

ARTIFICIA

INTEL

PERFORMANCE Leading Process Technology

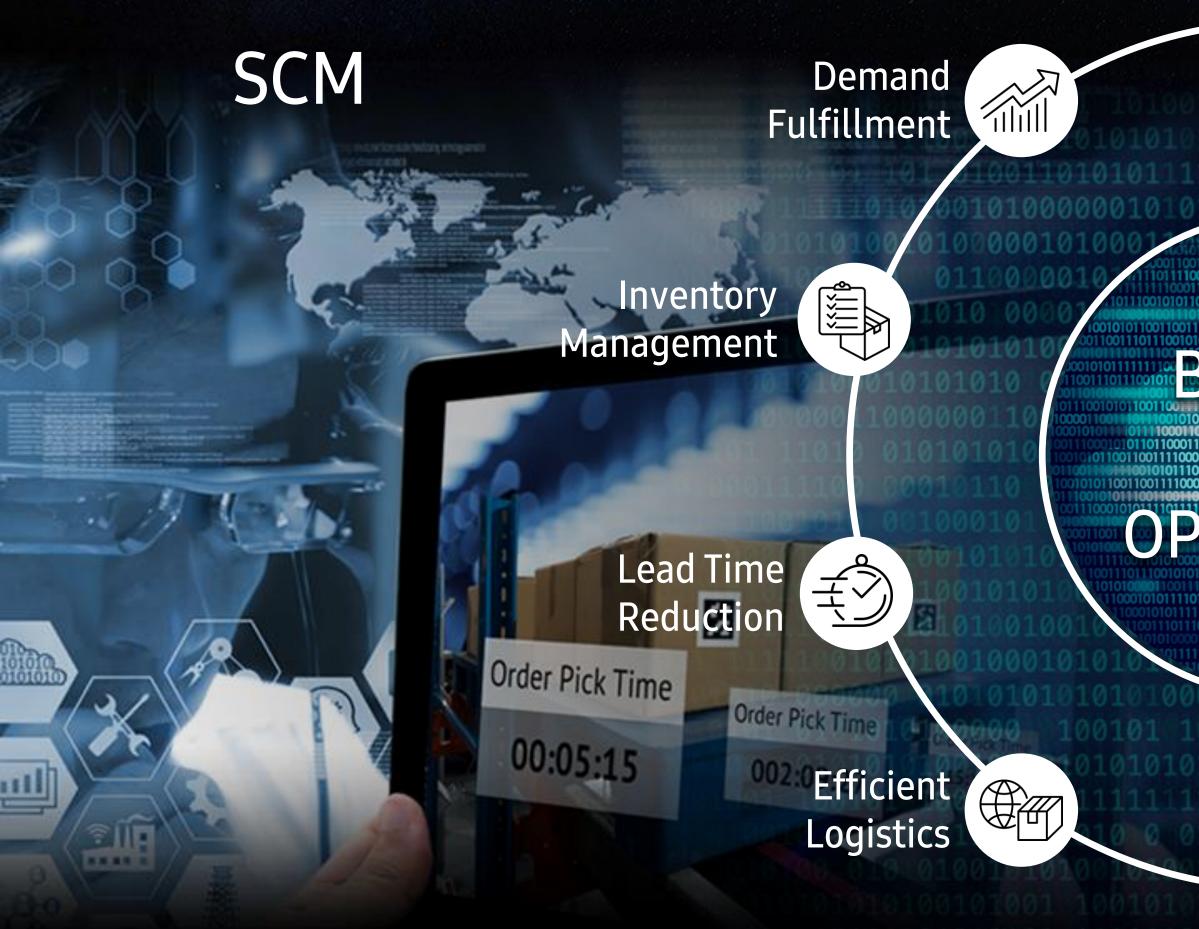
FLEXIBILITY DRAM/NAND Conversion

LONGEVITY Proven Process Technology



Advanced Manufacturing

EVOLUTION TO SMARTER FACTORY Customer Value Improvement through High Productivity and Enhanced SCM



* SCM: Supply Chain Management



Automated Operation

PRODUCTIVITY

I SU ETOCTT

Big Data Based OPERATION Seamless **Quality Control**

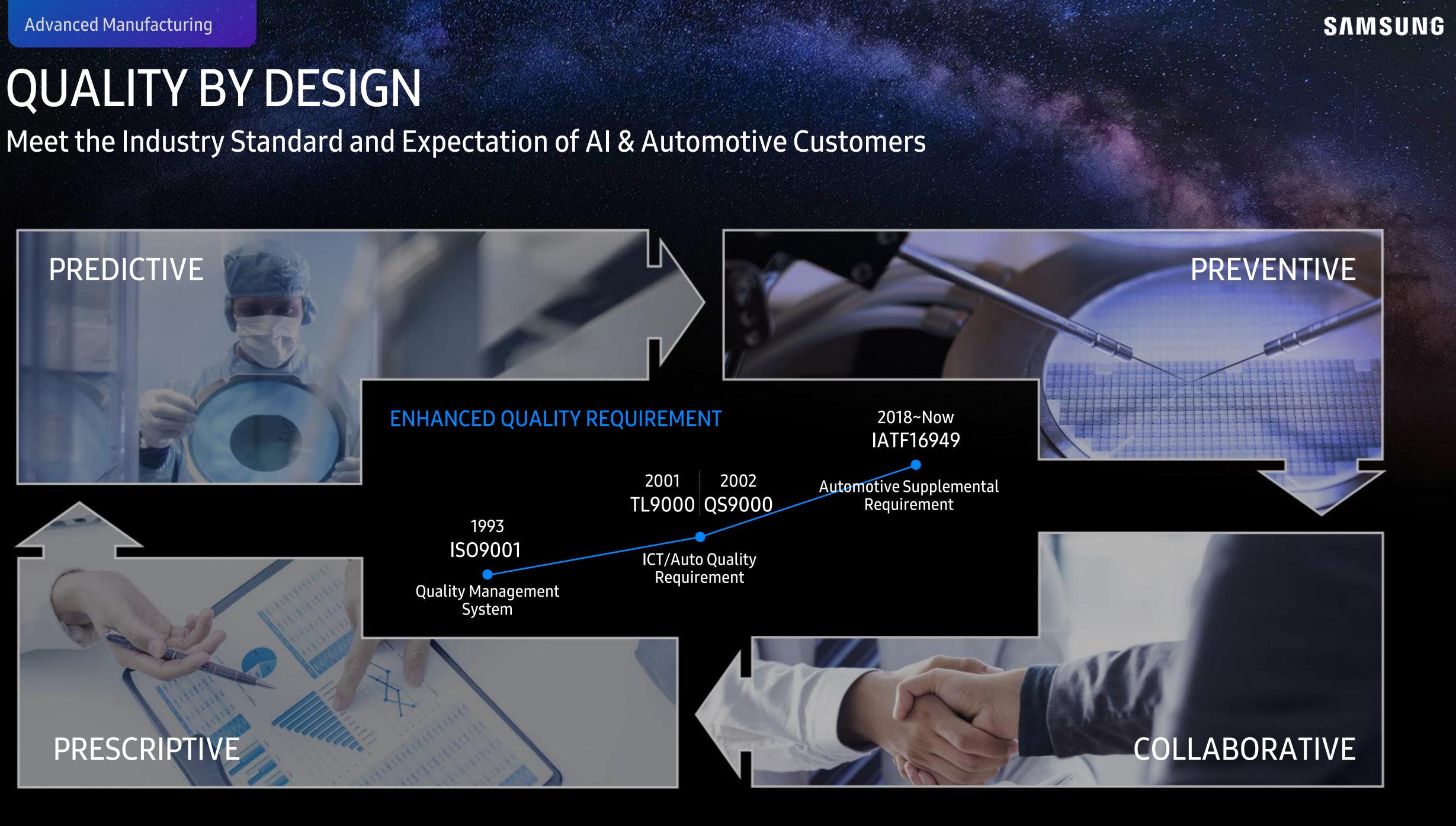
Intelligent میں میں میں Planning

Early Yield Improvement

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QUALITY BY DESIGN





Placing Memory at the Forefront of Future Innovation and Creative IT Life

Technology

Leading Technological Breakthroughs

Customers

Supporting Customers' Future Innovation

Employees

Fostering Employees' Creativity

Society

Enriching a New Way of Digital Life

http://www.samsung.com/semiconductor

